

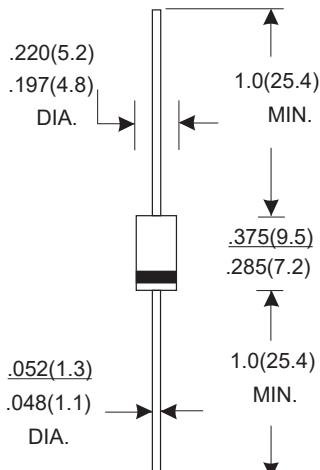
DO-27 SCHOTTKY BARRIER DIODE

FEATURES

- The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- Construction utilizes void-free molded plastic technique
- High reliability
- High temperature soldering guaranteed: 260 °C/10 seconds at terminals
- Component in accordance to RoHS 2015/863 and WEEE 2012/19/EU

MECHANICAL DATA

- Case style: DO-27 molded plastic
- Mounting position: Any



Dimensions in inches and (millimeters)

MAXIMUM RATINGS AND CHARACTERISTICS

@ 25°C Ambient Temperature (unless otherwise noted)

TYPE NUMBER	SYMBOL	SR 520	SR 530	SR 540	SR 550	SR 560	SR 580	SR 5100	SR 5200	UNITS						
Maximum recurrent peak reverse voltage	V _{RRM}	20	30	40	50	60	80	100	200	V						
Maximum RMS voltage	V _{RMS}	14	21	28	35	42	57	71	140	V						
Maximum DC blocking voltage	V _{DC}	20	30	40	50	60	80	100	200	V						
Maximum Average Forward rectified Current 0.375"(9.5mm) lead length	I _{F(AV)}	5.0								A						
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load	I _{FSM}	150.0								A						
Maximum instantaneous forward voltage at 5.0 A	V _F	0.55		0.70		0.85		0.90		V						
Maximum reverse current @ T _A =25°C at rated DC blocking voltage per diode	I _R	0.5								mA						
@ T _A =125°C		50.0		25.0												
Typical Thermal Resistance	R _{θJA}	25								°C/W						
Typical junction capacitance	C _j	500.0		400.0						pF						
Storage Temperature	T _{STG}	-55 ---- + 150								°C						
Operation Junction Temperature	T _j	-55 ---- + 120								°C						

RATINGS AND CHARACTERISTIC CURVES

FIG.1-FORWARD CURRENT CURRENT DERATING CURVE

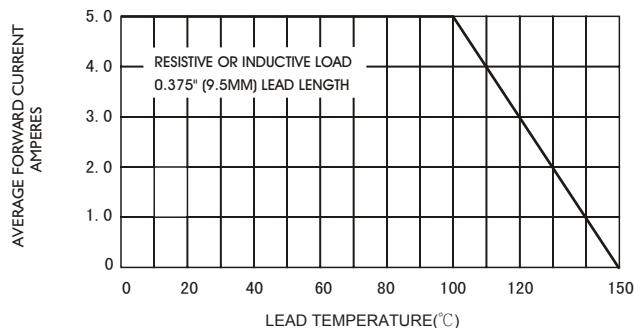


FIG.2-MAXIMUM NON-REPETITIVE PEAK

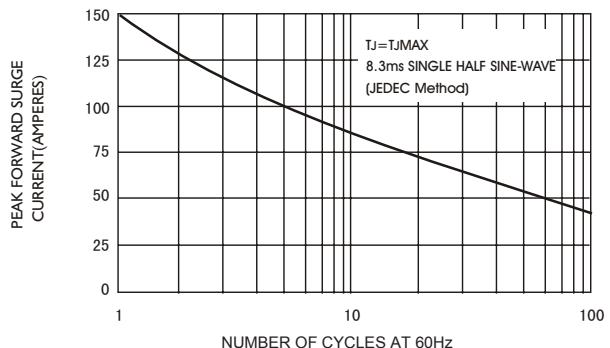


FIG.3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

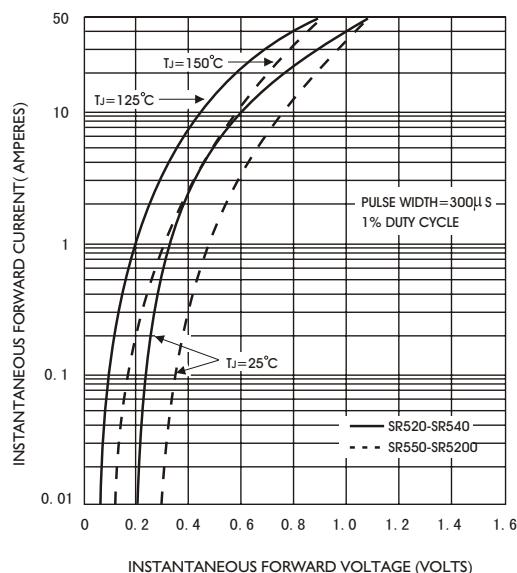


FIG.4-TYPICAL REVERSE CHARACTERISTICS

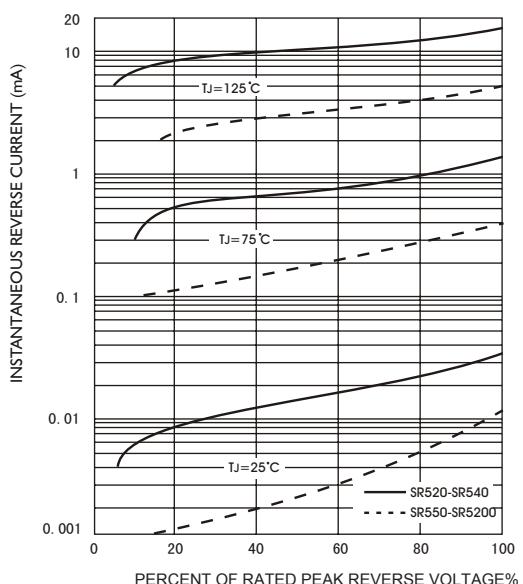


FIG.5-TYPICAL JUNCTION CAPACITANCE

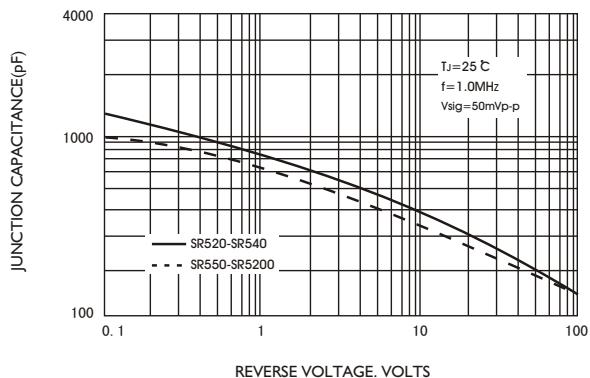


FIG.6-TYPICAL TRANSIENT THERMAL IMPEDANCE

